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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kenji Kitamura	05/23/2006
Shinichi Yataka	05/23/2006
Takao Endo	05/23/2006
Yuujiro Tominaga	05/23/2006
Toshihide Tanaka	05/23/2006
Koichiro Sato	05/23/2006

RECEIVING PARTY DATA

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Street Address:	1-1, Minami-Aoyama 2-chome
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City:	Tokyo
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10597136

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ATTORNEY DOCKET NUMBER:	16693
NAME OF SUBMITTER:	David E. Spaw
	PATENT

500125132 **REEL: 017925 FRAME: 0412**

Total Attachments: 3 source=16693#page1.tif source=16693#page2.tif source=16693#page3.tif

> PATENT REEL: 017925 FRAME: 0413

ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned in SEMICONDUCTOR DEVICE MODULE STRUCTURE

that are the subject of an application for a U.S. Patent, (Application No. 10/597136, filed 07/12/2006), which application is further identified as Rankin, Hill, Porter & Clark LLP Docket No. SHM-16693.

WHEREAS, <u>Honda Motor Co., Ltd.</u>, a corporation of <u>Japan</u>, and having a place of business at <u>1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo, Japan</u>, hereinafter referred to as "assignee", is desirous of acquiring all right, title, and interest throughout the world in, to, and under said improvements and inventions and patent rights therefor.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt and sufficiency of which are hereby acknowledged, all right, title, and interest, in the United States and throughout the world, in, to and under said improvements and inventions and all patents, patent applications, patent rights, and inventor's certificates thereof, therefor, and therein, including without limitation said application for patent in the United States, all divisions and continuations thereof, all patents which may be granted thereon, all reissues and extensions thereof, all right to sue for past infringement thereunder, all patents which may be granted for said improvements and inventions by states or nations other than the United States, or by other authority, entity, or organization, and all applications therefor, have been and are hereby sold, assigned, transferred, and delivered unto assignee, its successors and assigns; and it is covenanted and agreed by the undersigned, and for executors, administrators, and legal representatives of the undersigned, that at assignee's request any and all applications, affidavits, assignments, and other instruments will be made, executed, and delivered as may be necessary, or desirable to secure for or vest in assignee, its successors or assigns, any improvement, inventions, right, title, interest, application, patent, patent right or other right or property covered by this assignment, and the United States Commissioner of Patents and Trademarks is hereby requested and authorized to issue any and all United States patents granted on any of said applications to assignee as owner of the entire right, title, and interest in, to, and under the same, and appropriately empowered officials of foreign countries are hereby authorized to issue any letters patent granted on any of said applications to assignee as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Rankin, Hill, Porter & Clark LLP the power to insert on this assignment any identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

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IN WITNESS WHEREOF, this assignment has been executed below by the undersigned: (1) Inventor Name (sole or joint): Kenji KITAMURA Signature: Komi Today's Date: May 23, 2006 Witness: <u>Hitoshi</u> Inventor Name (sole or joint): Shinichi YATAKA
Signature: Shinichi Yataka (2) Today's Date: May 23, 2006 Witness: Sly Mky www. Witness: Hitashi Sheda (3) Inventor Name (sole or joint): Takao ENDO Signature: Takao Endo Today's Date: May 23, 2006 Witness: <u>Hitoshi</u> (4) Inventor Name (sole or joint): Yuujiro TOMINAGA Signature: <u>Junjino Tominaga</u> Today's Date: May 23, 2006 Witness: Ship Nokayana
Witness: Hitoshi I keda

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(5)	Inventor Name (sole or joint): Toshihide TANAKA
	Signature: <u>Joshlhide Janaka</u>
	Today's Date: May 23, 2006
	Witness: Shy Nokojur Witness: Hitoshi I keda
	Witness: <u>Hitoshi Lkeda</u>
(6)	Inventor Name (colo er jaint): Kajahira SATO
(6)	Inventor Name (sole or joint): Koichiro SATO
	Signature: <u>Kouhno</u> Sato
	Today's Date: May 23, 2006
	Witness: Ship Nohagen
	Witness: Kor Nobela Witness: Hitoshi Lkeda

RECORDED: 07/13/2006